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1 Introduction

Easy Core Tech. introduces the pioneer of the Bluetooth

5.0 modules EM6Q321B which is a high performance, cost effective, low power and compact solution. The Bluetooth module provides a complete 2.4GHz Bluetooth system based on the QCC3021 BGA chipset which is a single

chip radio and baseband IC for Bluetooth 2.4GHz systems. This module is fully qualified single-chip dual mode Bluetooth@v5.0 system.

2 Key Features

EM6Q321B(QCC3021) Features

- Qualified to Bluetooth® v5.0 specification
- 120 MHz Qualcomm® Kalimba[™] audio DSPs
- 32 MHz Developer Processor for applications
- Firmware Processor for system
- Flexible QSPI flash programmable platform
- Advanced audio algorithms
- High-performance 24-bit stereo audio interface
- Digital and analog microphone interfaces
- SBC, and AAC audio codecs support
- Serial interfaces: UART, Bit Serializer (I² C/SPI),USB 2.0
- Integrated PMU: Dual SMPS for system/digital circuits, Integrated Liion battery charger

Application subsystem

- Dual core application subsystem 32 MHz operation
 - 32-bit Firmware
 - Processor:
 - Reserved for
 - system use
 - Runs Bluetooth upper stack, profiles, house-keeping code
- 32-bit Developer Processor:Runs developer applications
- Both cores execute code from external flash memory using QSPI clocked at 32 MHz
- On-chip caches per core allow for optimized performance and power consumption

Bluetooth subsystem

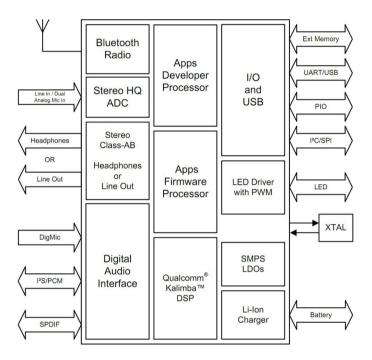
- Qualified to Bluetooth v5.0 specification including 2 Mbps Bluetooth low energy (Production parts)
- Single ended antenna connection with on-chip balun and Tx/Rx switch
- Bluetooth, Bluetooth low energy, and mixed topologies supported
- Class 1 support



3 Applications

• Wired/wireless speakers

4 Block Diagram



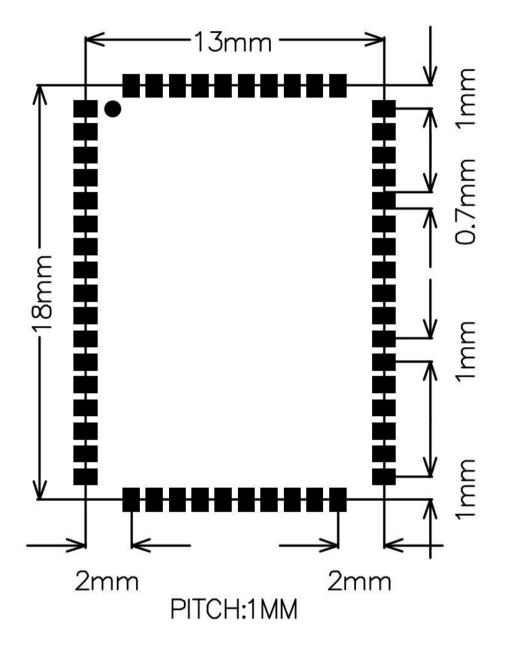
5 General specifications

Model Name	EM6Q321B	
Product Description	Bluetooth 5.0 Class2 Module	
Bluetooth Standard	Bluetooth 5.0	
Chipset	QCC3021 QFN	
Dimension	13mm x 18mm x 2.4mm	
Operating Conditions		
Voltage	2.8~4.2V	
Temperature	-10∼+70℃	
Storage Temperature	-40∼+85℃	
Electrical Specifications		
Frequency Range	2402~2480MHz	
Maximum RF Transmit Power	9dBm	
π /4 DQPSK Receive Sensitivity	-91dBm	
8DPSK Receive Sensitivity	-81dBm	



6 Module Package Information

6.1 Pinout Diagram and package dimensions



Unit: MM



Shenzhen Easy Core Technology Co,.LTD Website:www.easy-core.com Mail:info@easy-core.com Adress:4/F, Bldg.B, Hongxinbao IZ., No. 6 Feimei RD., Pingshan District, Shenzhen, Tel:(86)755-29653709 **6.2 Module Pin descriptions** PORT PIO20 PIO21 PIO22 PIO23 NC NC NC SND (PIN1)NC GND(PIN44) MIC1 P PI019 MIC1 N PI018 MIC2 P PI017 MIC2_N PI016 MIC BIAS PI015 **VBAT SENSE** GND USB DN SPKL P USB DP SPKL N SPKR P VCHG VCHG SENSE SPKR N CHG_EXT NC SYS CTRL **PIO1** VBAT **PIO2 PI07** GND **PI08** LED0 PI05(PIN28) (PIN17)LED1 PIO4 PIO3 PADS⁻ E ЧĞ SPI 18

Pin#	Pin Name	Pin type	Description
1	1 NC NC		NC
		Digital: Bidirectional with programmable	Programmable I/O line 19. Alternative
2	PIO[19]	strength internal pull- up/pull-down	function: PCM_DIN[0]
3	PIO[18] Digital: Bidirectional with programmable strength internal pull- up/pull-down Programmable I/O line 18. Alternative function: PCM_DOUT		Programmable I/O line 18. Alternative function: PCM_DOUT[0]
4	PIO[17]	Digital: Bidirectional with programmable strength internal pull- up/pull-down	Programmable I/O line 17. Alternative function: PCM_SYNC



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		Digital: Bidirectional with programmable	Programmable I/O line 16.
5	PIO[16]	strength internal pull- up/pull-down	Alternative function: PCM_CLK
		Digital: Bidirectional with programmable	Programmable I/O line 15.
6	PIO[15]	strength internal pull- up/pull-down	Alternative function: MCLK_OUT
7	VBAT_SENSE	Analog	Battery voltage sense input.
8	USB DN	Digital	USB Full Speed device D- I/O. IEC-61000-4-2
0			(device level) ESD Protection
9	USB DP	Digital	USB Full Speed device D+ I/O. IEC-61000-4-2
Ŭ	000_01	Digital	(device level) ESD Protection
10	VCHG	Supply	Charger input to Bypass regulator.
			Charger input sense pin after external
			mode sense-resistor. High impedance.
11	VCHG_SENSE	Analog	NOTE If using internal charger or no charger,
			connect VCHG_SENSE direct to VCHG.
			External charger transistor current control.
12	CHG_EXT	Analog	Connect to base of external charger transistor as
			per application schematic.
			Typically connected to an ON/OFF push button.
			Boots device in response to a button press when
			power is still present from battery and/or charger
	SYS_CTRL	S_CTRL Digital input	but software has placed the device in the OFF or
13			DORMANT state. Additionally useable as a digital
			input in normal operation. No pull.
			Additional function: PIO[0] input only
14	VBAT	Supply	Battery voltage input.
15	GND	Ground	Ground
		Analog or digital input/ open drain	General-purpose analog/digital input or open drain
16	AIO[0]/LED[0]	output.	LED output.
		Analog or digital input/ open drain	General-purpose analog/digital input or open drain
17	AIO[1]/LED[1]	output.	LED output.
		Analog or digital input/ open drain	General-purpose analog/digital input or open drain
18	AIO[2]/LED[2]	output.	LED output.
19	NC	NC	NC
		Analog or digital input/ open drain	General-purpose analog/digital input or open drain
20	AIO[5]/LED[5]	output.	LED output.
21	GND	Ground	Ground
22	1V8	Supply	1.8V voltage output.
23	VDD_PADS1	Supply	1.8 V/3.3 V PIO supply.
23	VDD_PADS3_4	Supply	1.8 V/3.3 V PIO supply.
24	VDD_FAD35_4		
25	PIO[4]	Digital: Bidirectional with programmable	Programmable I/O line 4.
		strength internal pull- up/pull-down	Alternative function: TBR_MOSI[1]
26	PIO[3]	Digital: Bidirectional with programmable	Programmable I/O line 3. Alternative function:
		strength internal pull- up/pull-down	TBR_MISO[2]
27	PIO[6]	Digital: Bidirectional with programmable strength	Programmable I/O line 6.
		internal pull- up/pull-down	Alternative function: TBR_MOSI[0]



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~~	DIOISI	Digital: Bidirectional with programmable	Programmable I/O line 5.
28	PIO[5]	strength internal pull- up/pull-down	Alternative function: TBR_MISO[1]
		Digital: Bidirectional with programmable	Programmable I/O line 8.
29	PIO[8]	strength internal pull- up/pull-down	Alternative function: TBR_CLK
		Digital: Bidirectional with programmable	Programmable I/O line 7. Alternative function:
30	PIO[7]	strength internal pull- up/pull-down	TBR_MISO[0]
		Digital: Bidirectional with programmable	Programmable I/O line 2. Alternative function:
31	PIO[2]	strength internal pull- up/pull-down	TBR_MISO[3]
			Automatically defaults to RESET# mode when
		Digital: Bidirectional with programmable	the device is unpowered, or in off modes.
32	PIO[1]	strength internal pull- up/pull-down	Reconfigurable as a PIO after boot. Alternative
			function: Programmable I/O line 1
33	NC	NC	NC
			Headphone/speaker differential right output,
34	AUDIO_HPR_N/ SPKR_N	Analog	negative. Alternative function:
			Differential right line output, negative
			Headphone/speaker differential right output,
35	AUDIO_HPR_P/	Analog	positive. Alternative function:
s	SPKR_P		
			Differential right line output, positive Headphone/speaker differential left output,
	AUDIO_HPL_N/		
36	SPKL_N	Analog	negative. Alternative function:
			Differential left line output, negative
	AUDIO_HPL_P/		Headphone/speaker differential left output,
37	SPKL_P	Analog	positive. Alternative function:
			Differential left line output, positive
38	GND	Ground	Ground
39	AUDIO_MIC_BIAS	Analog	Mic bias output.
			Microphone differential 2 input, negative.
40	AUDIO_MIC2_N/	Analog	Alternative function:
+0	LINEIN_R_N	Analog	Differential audio line input right, negative
			Microphone differential 2 input, positive.
41	AUDIO_MIC2_P/	Analog	Alternative function:
+ 1	LINEIN_R_P	Analog	Differential audio line input right, positive
			Microphone differential 1 input, negative.
42	AUDIO_MIC1_N/	Analog	Alternative function:
+2	LINEIN_L_N	Analog	Differential audio line input left, negative
			Microphone differential 1 input, positive.
13	AUDIO_MIC1_P/	Analog	Alternative function:
+3	LINEIN_L_P	Analog	Differential audio line input left, positive
44	GND	Ground	Ground
45	GND	Ground	Ground
46	BT_RF	RF	Bluetooth transmit/receive.
47	GND	Ground	Ground
48	NC	NC	NC



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49	NC	NC	NC	
50	NC	NC	NC	
		Digital: Bidirectional with programmable		
- 1	BIOTOD	strength internal		
51	PIO[23]	pull- up/pull-down	Programmable I/O line 23.	
		Digital: Bidirectional with programmable		
50	DIOIO01	strength internal	Bragrammahla 1/0 lina 22	
52	PIO[22]	pull- up/pull-down	Programmable I/O line 22.	
		Digital: Bidirectional with programmable	Programmable I/O line	
	PIO[21]	strength internal	21. Alternative function:	
53		pull- up/pull-down	PCM_DOUT[2]	
		Digital: Bidirectional with programmable	Programmable I/O line	
F A	PIO[20]	strength internal	20. Alternative function:	
54		pull- up/pull-down	PCM_DOUT[1]	

7 Electrical Characteristics

7.1 Absolute Maximum Ratings

Rating	Minimum	Maximum
Storage temperature	-40 ℃	+85 ℃

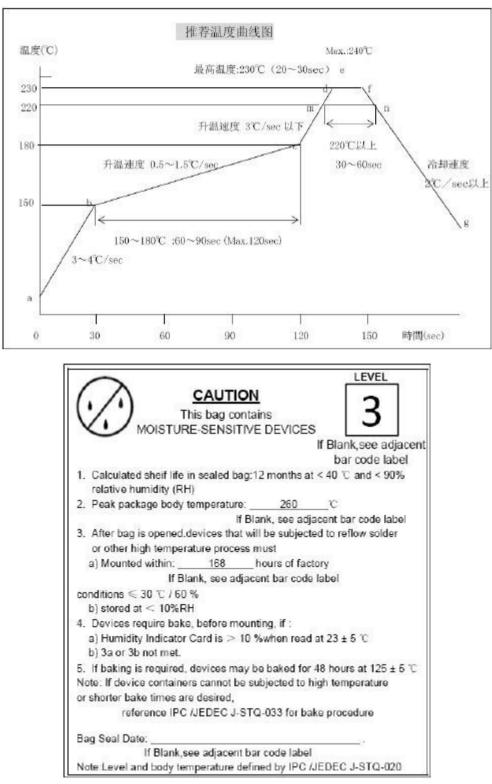
7.2 Recommended Operating Conditions

Operating Condition	Minimum	Maximum
Operating temperature range	-10 ℃	+70 ℃
Supply voltage: VBAT	+2.8V	+4.2V

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8 Recommended reflow temperature profile



The module Must go through 125°C baking for at least 9 hours before SMT AND IR reflow process!

Record of Changes

Data	Revision	Description	
2019-11-25	V1.0	Original publication of this document.	
2020-04-23	V1.1	Fix PIN definition.	
2020-06-29	V1.2	Update product model.	

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